



STPMS1

Dual-channel 1-bit, 2 MHz, 1st order sigma-delta modulator with embedded PGA

Features

- V_{CC} supply range: 3.2 V - 5.5 V
- Two 1st order sigma-delta modulators
- Programmable chopper-stabilized low noise and low offset amplifier
- Supports 50-60 Hz AC watt meters
- Internal low-drop regulator at 3 V (typ.)
- Precision voltage reference: 1.23 V and 30 ppm/°C (typ.)

Applications

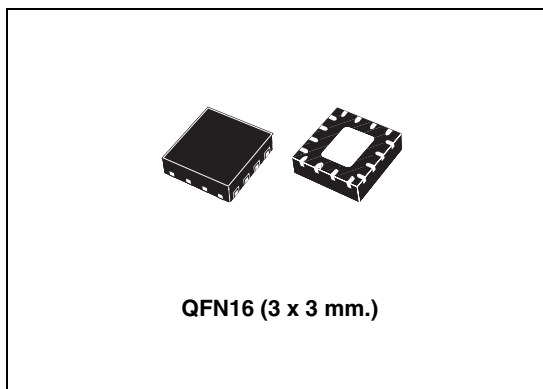
- Power metering
- Motor control
- Industrial process control
- Weight scale
- Pressure transducers

Description

The STPMS1, also called a smart-sensor device, is an ASSP designed for effective measurement in power line systems utilizing the Rogowski coil, current transformer, or shunt principle. It is used in combination with the STPMC1 programmable poly-phase energy calculator IC, as a building block for single-phase or poly-phase energy meters. The STPMS1 is a mixed signal IC consisting of an analog and a digital section. The analog section consists of a pre-amplifier and two 1st order $\Sigma\Delta$ modulator blocks, band-gap voltage reference, a low-drop voltage regulator, and DC buffers, while the digital section consists of a clock generator and output multiplexer. This device is designed for use in medium resolution

Table 1. Device summary

Order code	Package	Packaging
STPMS1BPQR	QFN16 (3 x 3 mm)	2500 parts per reel



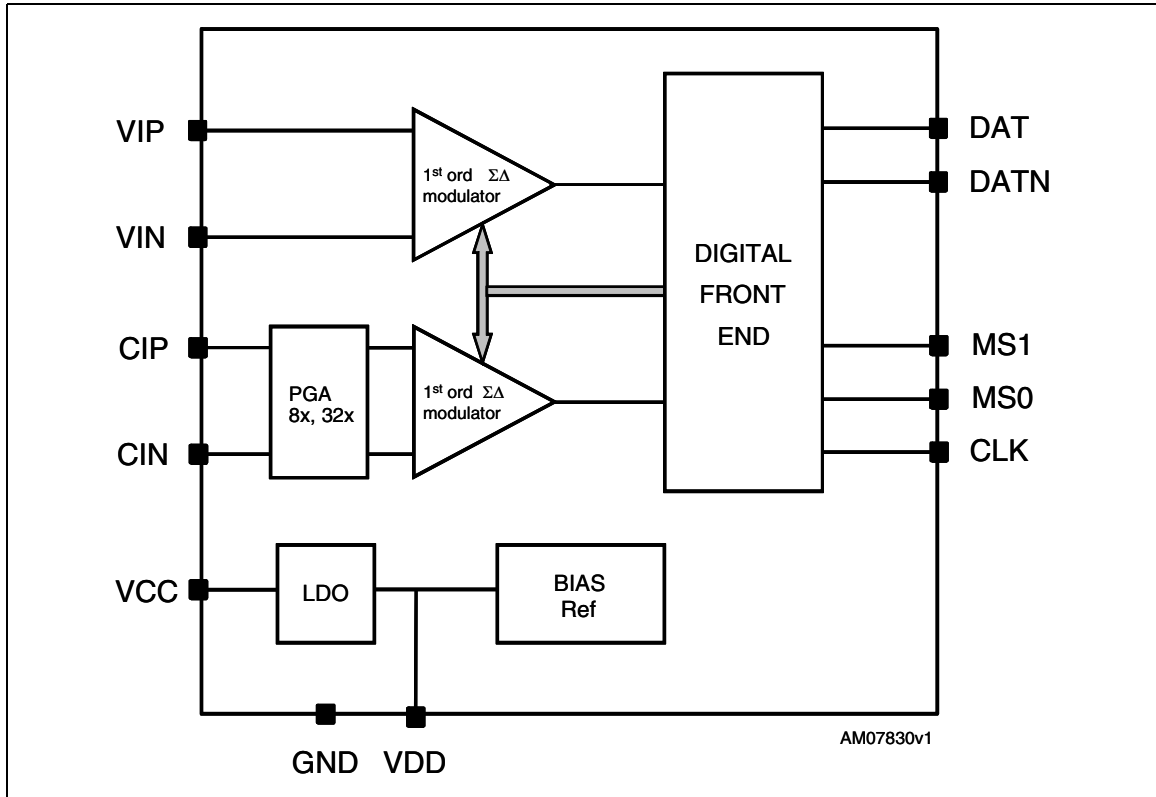
measurement applications when single or double inputs must be monitored at the same time.

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1 Schematic diagram

Figure 1. Block diagram



2 Pin configuration

Figure 2. Pin connection (top view)

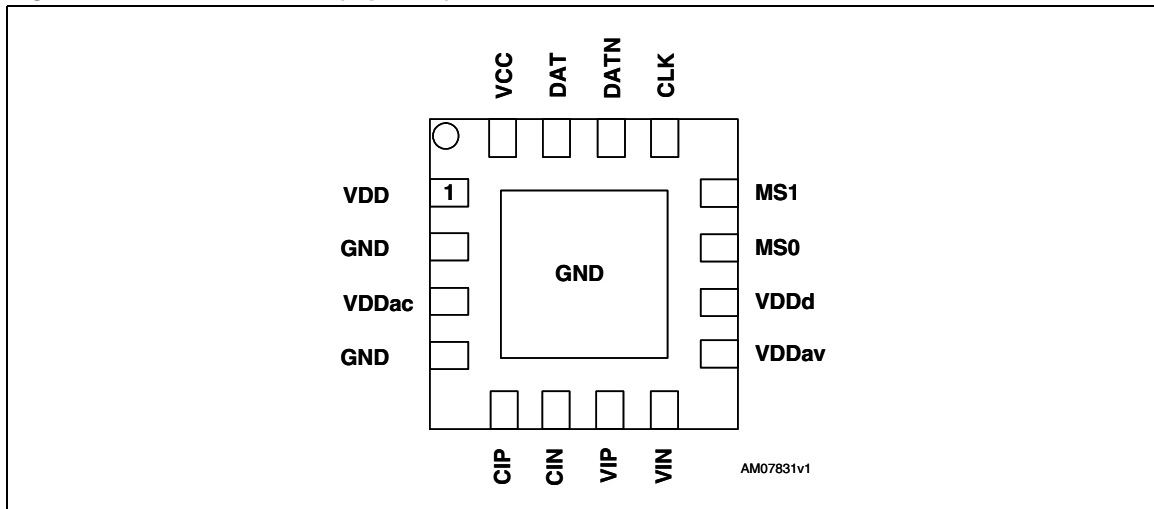


Table 2. Pin description

Pin	Symbol	Description
1	VDD	+ 3.0 V output of LDO
2	GND	Ground level for signals and pin protection
3	VDDac	Current channel modulator supply input
4	GND	Ground level for signals and pin protection
5	CIP	Current channel +
6	CIN	Current channel -
7	VIP	Voltage channel +
8	VIN	Voltage channel -
9	VDDav	Voltage channel modulator supply input
10	VDDd	Digital front-end supply input
11	MS0	Input for configurator 0
12	MS1	Input for configurator 1
13	CLK	Input for external measurement clock
14	DAT	Output of multiplexed $\Sigma\Delta$ signal
15	DATn	Output of multiplexed $\Sigma\Delta$ signal negated
16	VCC	Unregulated supply voltage
Exp PAD	GND	Ground level for signals and pin protection

3 Electrical characteristics

Table 3. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{CC}	DC input voltage	-0.3 to 6	V
I _{PIN}	Current on any pin (sink/source)	±150	mA
V _{ID}	Input voltage at digital pins (MS0, MS1, CLK, DAT, DATN)	-0.3 to V _{CC} +0.3	V
V _{IA}	Input voltage at analog pins (VIP, VIN, CIP, CIN)	-0.7 to 0.7	V
ESD	Human body model (all pins)	±3.5	kV
T _{OP}	Operating ambient temperature	-40 to 85	°C
T _J	Junction temperature	-40 to 150	°C
T _{STG}	Storage temperature range	-55 to 150	°C

Note: Absolute maximum ratings are those values beyond which damage to the device may occur. Functional operation under these conditions is not implied.

Table 4. Thermal data

Symbol	Parameter	Value	Unit
R _{thJA}	Thermal resistance junction-ambient	38.10 ⁽¹⁾	°C/W

1. This value refers to a single-layer PCB, JEDEC standard test board.

4 General operating conditions

$V_{CC} = 5\text{ V}$, $T_A = 25\text{ °C}$, $2.2\text{ }\mu\text{F}$ between V_{DD} and GND, 100 nF between V_{CC} and GND,
 $f_{CLK} = 2.048\text{ MHz}$ unless otherwise specified.

Table 5. General operating conditions

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
General section						
V_{CC}	Operating supply voltage		3.165		5.5	V
I_{CC}	Quiescent current	1.049 MHz; $V_{CC}=3.165\text{ V}$; $C_L=100\text{ nF}$, no loads		2.5		mA
V_{POR}	Power on reset on V_{CC}			2.5		V
V_{DD}	Regulated supply voltage	1.049 MHz; $V_{CC}=3.2\text{ V}$; $C_L=100\text{ nF}$, no loads	2.85	3.00	3.15	V
I_{LATCH}	Current injection latch-up immunity				300	mA
f_{CLK}	Nominal frequencies		1.0		2.458	MHz
DC measurement accuracy						
	Resolution		11		16	bit
INL	Integral non-linearity	Result referred to a 13-bit resolution of CIP-CIN channel		0.35		LSB
		Result referred to a 9-bit resolution of VIP-VIN channel		0.5		
DNL	Differential linearity	Result referred to a 13-bit resolution of CIP-CIN channel		0.2		LSB
		Result referred to a 9-bit resolution of VIP-VIN channel		0.4		
	Offset error	Result referred to a 13-bit resolution of CIP-CIN channel		0.15		LSB
		Result referred to a 9-bit resolution of VIP-VIN channel		0.05		
	Gain error	Result referred to a 13-bit resolution of CIP-CIN channel		0.05		LSB/ μV
		Result referred to a 9-bit resolution of VIP-VIN channel		0.001		
NF	Noise floor	CIP-CIN channel, Gain 8x		115		dB
$PSRR_{DC}$	Power supply DC rejection	Voltage signal: $200\text{ mV}_{rms}/50\text{ Hz}$ Current signal: $10\text{ mV}_{rms}/50\text{ Hz}$ $f_{CLK}= 2.048\text{ MHz}$ $V_{CC}=3.3\text{ V}\pm 10\%$, $5\text{ V}\pm 10\%$			0.2	%

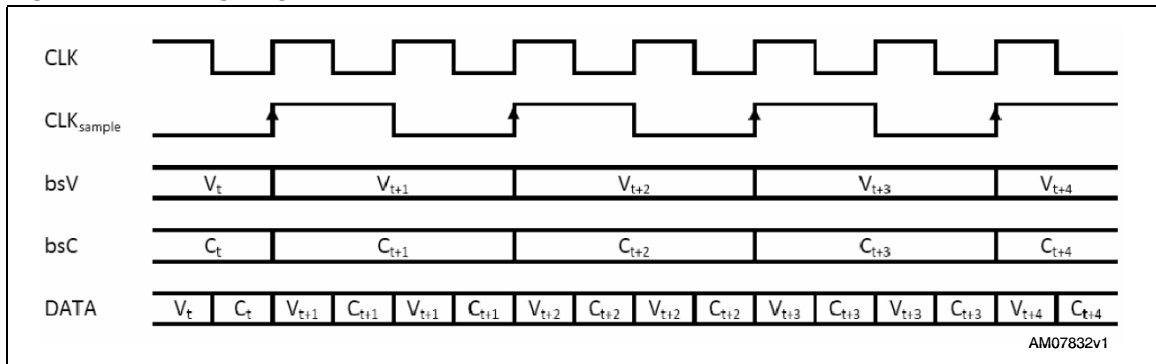
Table 5. General operating conditions (continued)

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
AC measurement accuracy						
SNR	Signal to noise ratio	CIP-CIN channel – Vin=±120 mV @ 55 Hz Gain 8x		65		dB
		VIP-VIN channel – Vin=±230 mV @ 55 Hz		50		
SINAD	Signal to noise ratio + distortion	CIP-CIN channel – Vin=±120 mV @ 55 Hz Gain 8x		65		dB
		VIP-VIN channel – Vin=±230 mV @ 55 Hz		50		
THD	Total harmonic distortion	CIP-CIN channel – Vin=±120 mV @ 55 Hz Gain 8x		-80		dB
		VIP-VIN channel – Vin=±230 mV @ 55 Hz		-70		
SFDR	Spurious free dynamic range	CIP-CIN channel – Vin=±120 mV @ 55 Hz Gain 8x		80		dB
		VIP-VIN channel – Vin=±230 mV @ 55 Hz		50		
PSRR _{AC}	Power supply AC rejection	Voltage signal: 200 mV _{rms} /50 Hz Current signal: 10 mV _{rms} /50 Hz f _{CLK} = 2.048 MHz V _{CC} =3.3 V+0.2 V _{rms} 1 @ 100 Hz V _{CC} =5.0 V+0.2 V _{rms} 1 @ 100 Hz			0.1	%
Analog inputs (CIP, CIN, VIP, VIN)						
V _{MAX}	Maximum input signal levels	VIP-VIN channel	-0.3		+0.3	V
		CIP-CIN channel Gain 8X Gain 32X	-0.15 -0.035		+0.15 +0.035	V
f _{SPL}	A/D sampling frequency			f _{CLK} /2		Hz
V _{off}	Amplifier offset				±20	mV
Z _{IP}	VIP, VIN impedance	Over the total operating voltage range	200		400	kΩ
Z _{IN}	CIP, CIN impedance	Over the total operating voltage range		240		kΩ
G _{ERR}	Current channel gain error			±10		%
I _{ILV}	Voltage channel leakage current	V _{CC} = 5.3 V, f _{CLK} = 1.049 MHz	-1		1	μA
I _{ILI}	Current channel leakage current		-1		1	
		Input enabled	-10		10	
Digital I/O (CLK, DAT, DATn, MS0, MS1)						
V _{IH}	Input high voltage		0.75 V _{CC}		5.3	V
V _{IL}	Input low voltage		-0.3		0.25V _{CC}	V

Table 5. General operating conditions (continued)

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
V _{OH}	Output high voltage	I _O =-1 mA, C _L =50 pF, V _{CC} =3.2 V	V _{CC} -0.4			V
V _{OL}	Output low voltage	I _O =+1 mA, C _L =50 pF, V _{CC} =3.2 V			0.4	V
I _{UP}	Pull up current			15		μA
t _{TR}	Transition time	C _{LOAD} =50 pF		10		ns
t _L	Latency	From 50 % of CLK to 50 % to DAT		40		ns
Clock input						
f _{CLK}	Nominal frequencies	Low precision	1.0		1.228	MHz
		High precision	2.0		2.458	MHz
On chip reference voltage						
V _{REF}	Reference voltage		1.21	1.23	1.25	V
T _C	Temperature coefficient	After calibration		30	50	ppm/°C

Figure 3. Timing diagram



CLK - clock signal on CLK pin
 CLK_{sample} - sigma-delta sample frequency
 bsV - sigma-delta bitstream of voltage signal
 bsC - sigma-delta bitstream of current signal
 DATA - multiplexed data of voltage and current signal on DAT pin

5 Application

The choice of external components in the transduction section of the application is a crucial point in the application design, affecting the precision and the resolution of the whole system.

Among the several considerations, a compromise must be found between the following needs:

1. Maximize the signal to noise ratio in the voltage and current channel
2. Choose the current to voltage conversion ratio K_s and the voltage divider ratio in a way that calibration can be achieved (see also the AN2299; *Fast digital calibration procedure for STPM01 based energy meters*, application note)
3. Choose K_s to take advantage of the whole current dynamic range according to desired maximum current and resolution.

To maximize the signal to noise ratio of the current channel the voltage divider resistors ratio should be as close as possible to that shown in [Table 6](#).

[Figure 4](#) below shows a reference schematic for an application with the following properties:

- $P = 64000 \text{ imp/kWh}$
- $INOM = 5 \text{ A}$
- $IMAX = 60 \text{ A}$

Typical values for the current sensors sensitivity are indicated in [Table 6](#).

Figure 4. Timing diagram

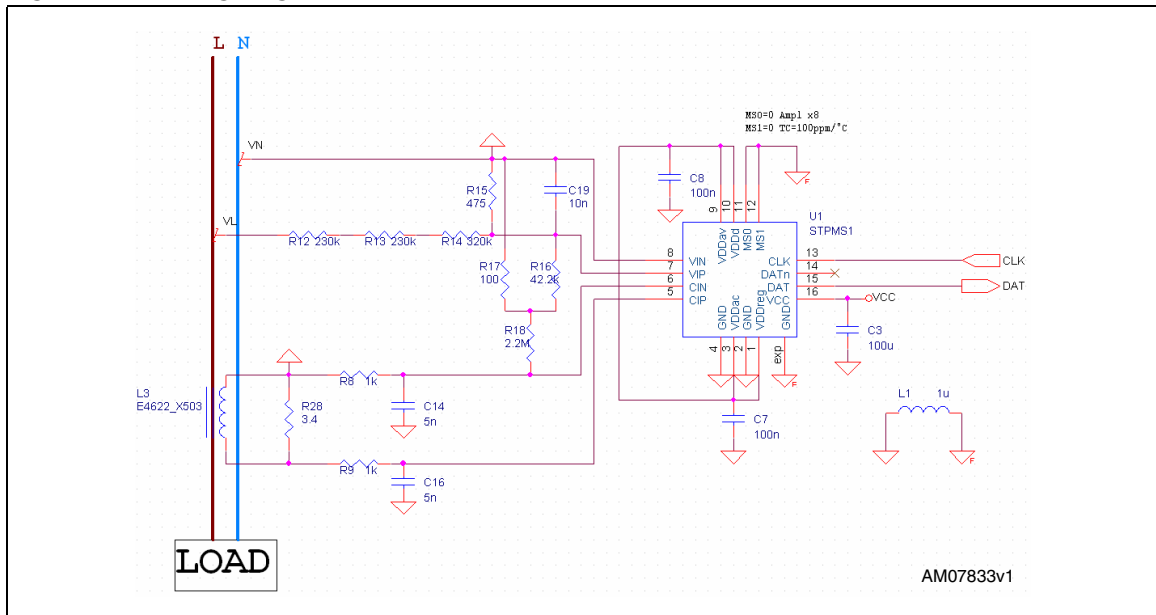


Table 6. Suggested external components in metering applications

Function	Component	Description	Value	Tolerance		Unit
	Calculator	STPMC1	---	---	---	---
Line voltage interface	Resistor divider	R to R ratio $V_{RMS}=230\text{ V}$	1:1650	$\pm 1\%$	50 ppm/ $^{\circ}\text{C}$	V/V
		R to R ratio $V_{RMS}=110\text{ V}$	1:830			
Line current interface	Rogowski coil	Current to voltage ratio K_S	0.15	$\pm 5\%$	50 ppm/ $^{\circ}\text{C}$	mV/A
	CT		1.7	$\pm 5\%$		
	Shunt		0.43	$\pm 5\%$		

Note: The above listed components refer to typical metering applications. However, STPMS1 operation is not limited to the choice of these external components.

Figure 5. Simplified application schematics for STPMC1 based energy metering

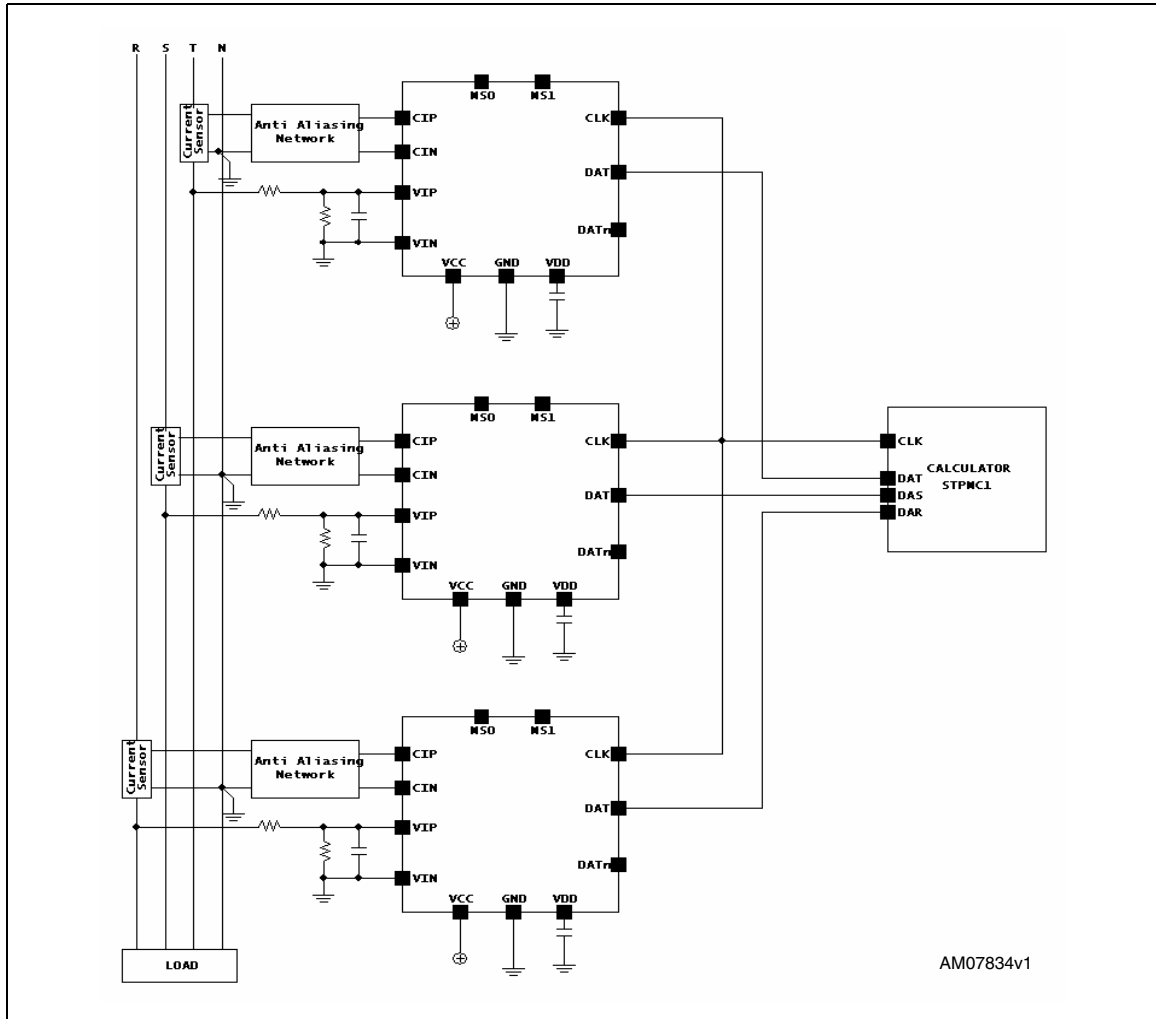
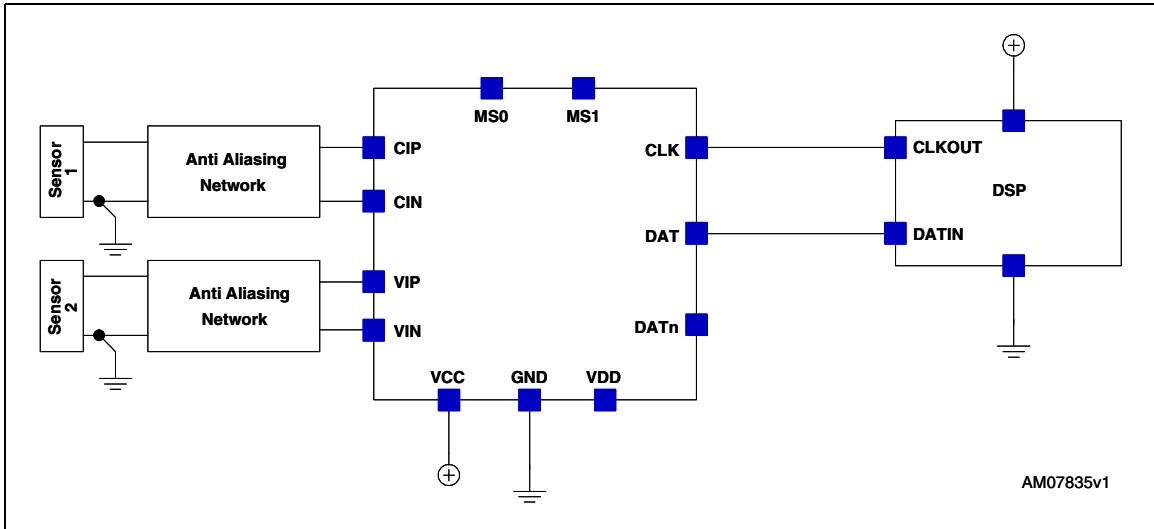


Figure 6. Connection schematic for DSP based applications



6 Terminology

6.1 Conventions

The lowest analog and digital power supply voltage is named GND which represents the system Ground. All voltage specifications for digital input/output pins are referred to GND.

Positive currents flow into a pin. Sinking current means that the current is flowing into the pin and then it is positive. Sourcing current means that the current is flowing out of the pin and then it is negative.

Timing specifications of a signal treated by a digital control part are relative to CLK. This signal is provided from the STPMC1 calculator IC of 1.024 MHz or of 2.048 MHz nominal frequency.

A positive logic convention is used in all equations.

6.2 Notation

Current and voltage signals are represented as u and i .

7 Typical performance characteristics

Figure 7. SNRH of CIP-CIN channel, gain 32x Figure 8. SNRH of CIP-CIN channel, gain 8x

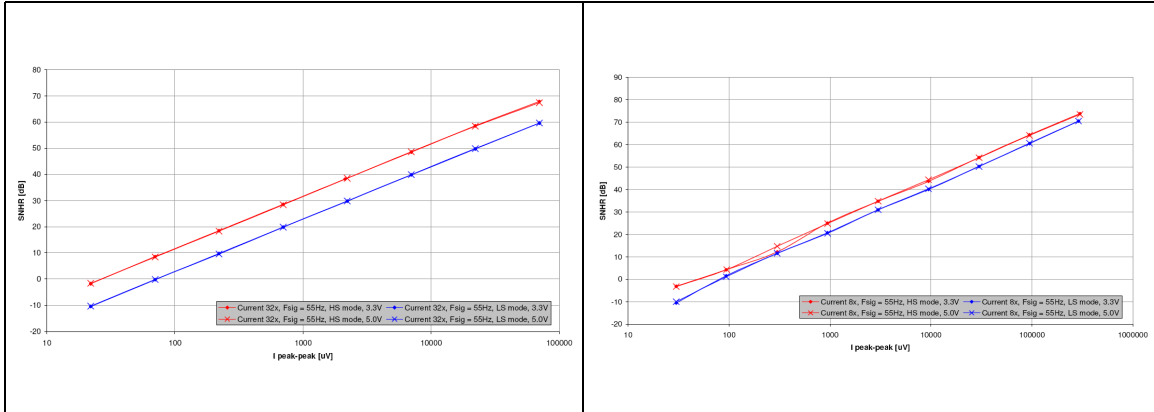


Figure 9. SNHR of VIP-VIN channel

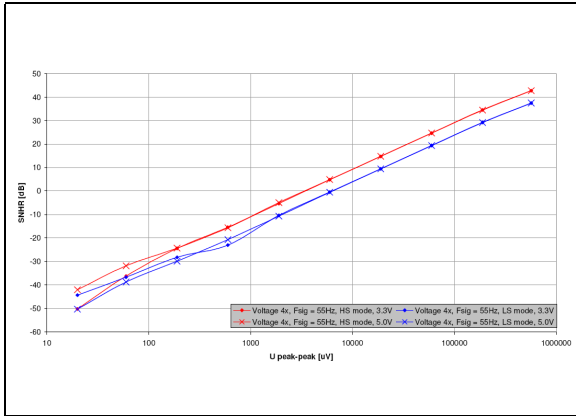


Figure 10. SINAD of CIP-CIN channel, gain 32x

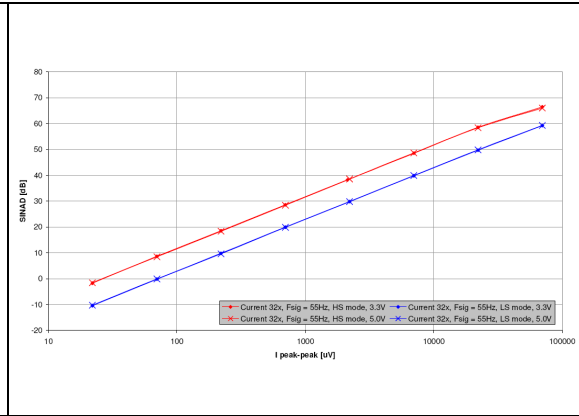


Figure 11. SINAD of CIP-CIN channel, gain 8x

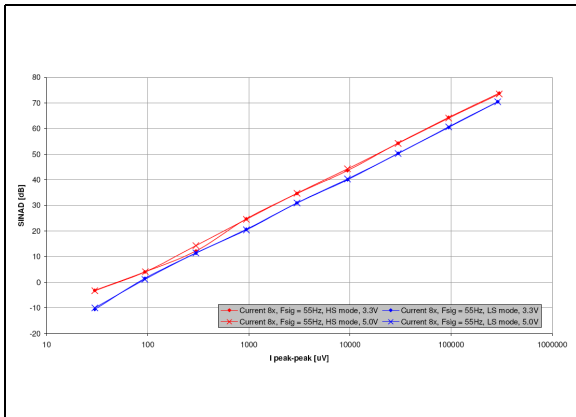


Figure 12. SINAD of VIP-VIN channel

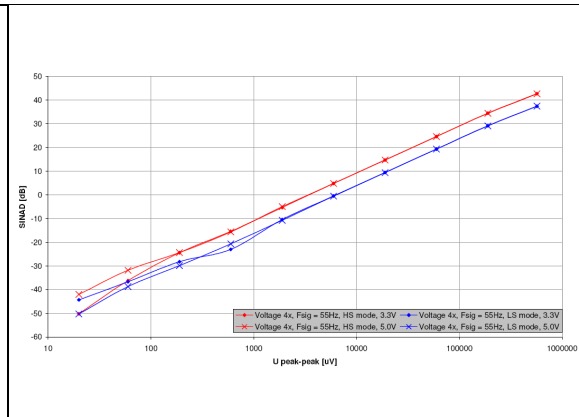


Figure 13. Relative gain error of CIP-CIN channel, gain 32x

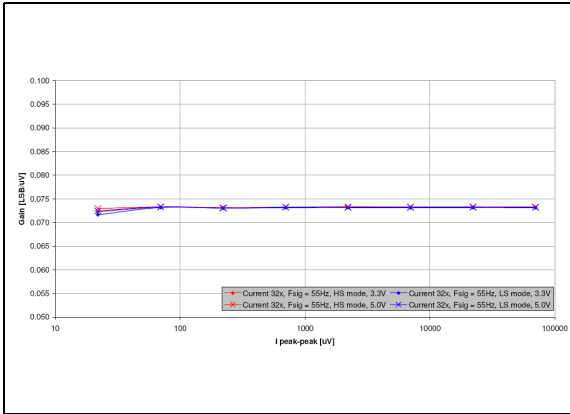


Figure 14. Relative gain error of CIP-CIN channel, gain 8x

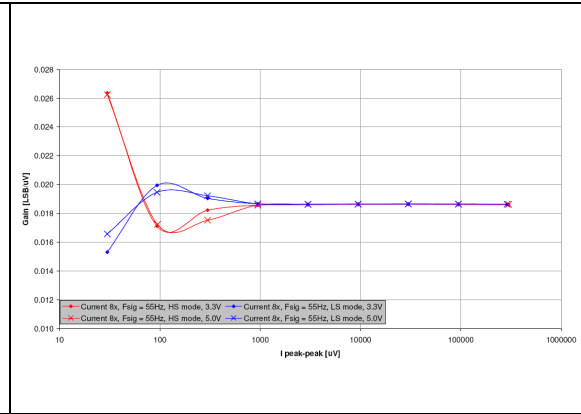


Figure 15. Relative gain error of VIP-VIN channel

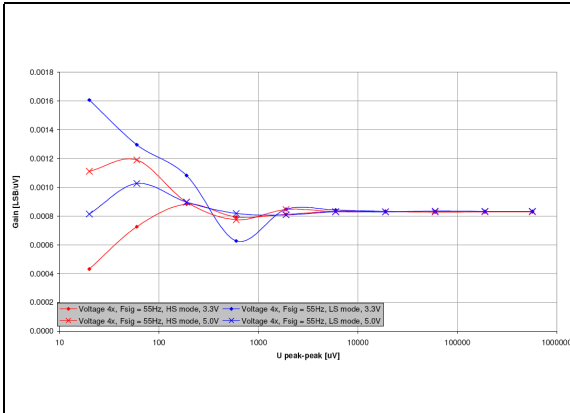
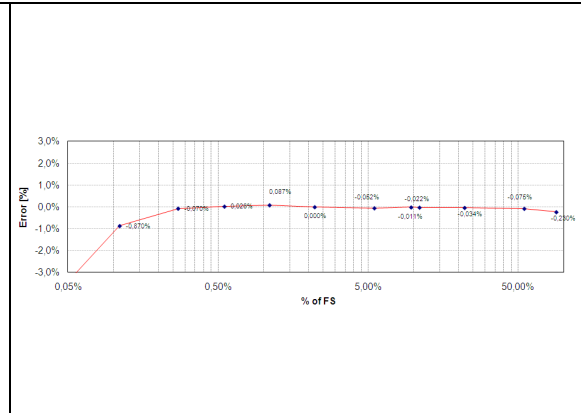


Figure 16. Accuracy over dynamic range



8 Theory of operation

8.1 General operation description

The STPMS1 performs first-order analog modulation of signals which have frequencies varying from DC to 2 kHz on two independent channels in parallel. There is a current channel for measuring line current and a voltage channel for measuring line voltage. The outputs of the converters provide two streams of digital ones and zeros which are therefore multiplexed in time to reduce the number of external connections.

The sampling and the data multiplexing are driven by an external clock signal, as it is used to strobe the analog inputs. The combination of one or more STPMS1s and an STPMC1 (which implements the digital filtering) constitutes a conversion system for energy metering applications.

The STPMS1 can also be used along with a DSP programmed to demultiplex the output bitstream and to implement the digital filtering as a medium resolution ADC system.

When used in energy metering applications, the voltage channel is connected externally and differentially to a line voltage divider which provides an analog signal proportional to the voltage u . The current channel is connected to a Rogowski coil, or to a current transformer (CT) or a shunt, which are used to interface the line current. The Rogowski coil provides an analog signal proportional to di/dt , while the shunt or CT provides an analog signal proportional to the current i . A CT differs from a shunt in sensitivity and phase error. There should be an anti-aliasing LP filter inserted between the sensors and the inputs of both channels of the STPMS1.

Internally, the differential voltage input related to the voltage channel is connected directly to the A/D converter, which implies an amplification of x4. On the other side, the differential voltage input related to the current channel is connected first to a configurable x2 or x8 pre-amplifier and the output of this pre-amplifier to the similar A/D converter (x4 gain), which implies selectable pre-amplification of x8 or x32 and uses the same reference voltage.

A pair of digital inputs (MS0 and MS1) is used to configure the device.

8.2 Function description of the analog part

The supply pins for the analog part are V_{CC} , V_{DD} , V_{DDac} , V_{DDav} , V_{DDd} , and GND.

The GND pin also represents a reference point. The V_{DD} is an analog I/O pin of an internal +3.0 V low-drop voltage regulator, the V_{DDac} and V_{CCav} are the modulators supply inputs, while the V_{DDd} is the digital front-end supply input. A 100 nF capacitor should be connected between V_{DDxx} and GND. The input of the mentioned regulator is V_{CC} which powers also a band-gap, and bias generators.

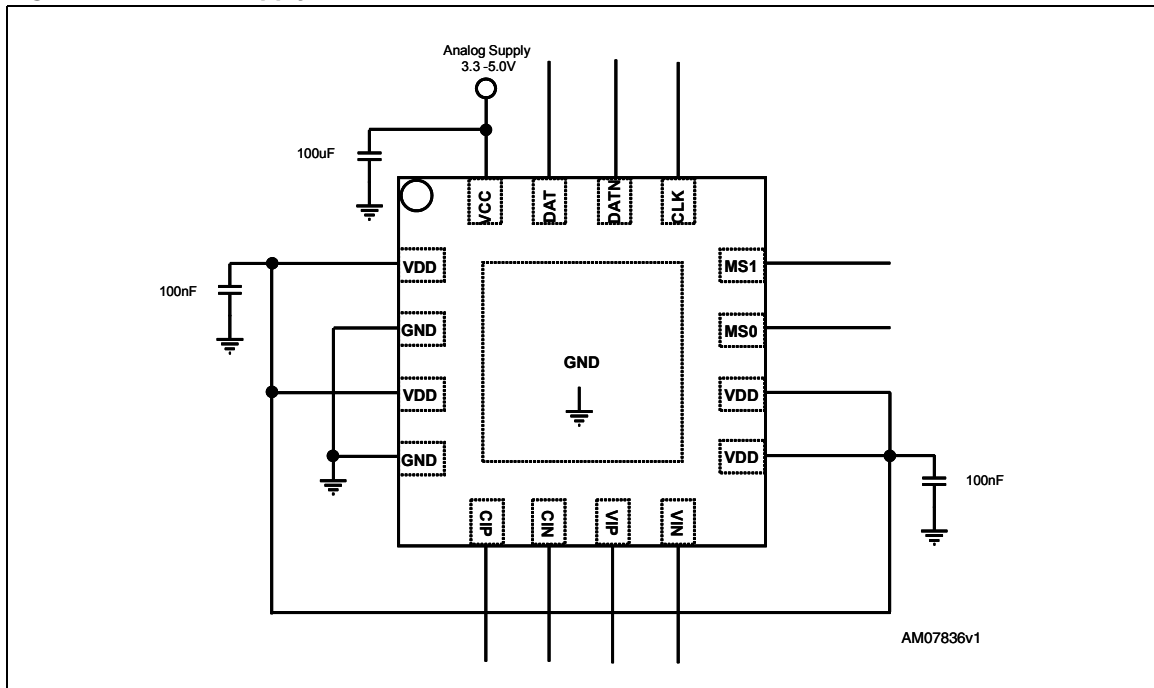
The analog part consists of several modules:

- Band-gap reference and bias generators
- +3 V low-drop regulator
- two DC buffer amplifiers
- two $\Sigma\Delta$ AD converters
- control signal module

The band-gap voltage reference is used as the reference level source for the low-drop module and for the AD converters. This module produces several bias currents and voltages for all other analog modules.

The low-drop regulator generates the +3.0 V power supply level. This level is used to power the DC buffers, pre-amplifier, and AD converter pair in the analog part of the device and whole digital part. It is brought out as V_{DD} for external connections. As part of low-drop, there is a power on reset (POR) detection circuit, which blocks all functions of the STPMS1 by asserting the reset condition whenever a V_{CC} supply level is less than +2.5 V.

Figure 17. Power supply external connection scheme



In order to enable proper operation of the switched capacitor (SC) section of AD converters, two DC buffers are added to the device. One is buffering the voltage reference level and the other is buffering the level of value equal to $(V_{DD}-V_{SS})/2$.

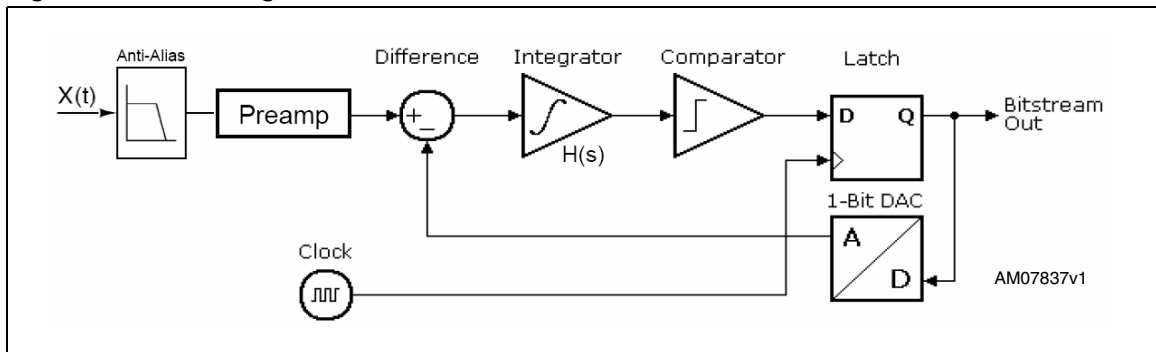
The AD converter block is further split into a voltage and current channel. Each channel consists of a differential pre-amplifier, SC integrator, comparator, amplifier bias block, and all necessary switches. The voltage channel SC integrator has a gain of 2 and there is no pre-amplifier block. The current channel SC integrator has a gain of 2 or 8, which can be selected by MS0 input, and has a pre-amplifier with a gain of 4.

The amplitude of the input signal to the AD converter block must be kept less than $0.45 V_{ref}$.

The output of each channel is input to the digital module as $\Sigma\Delta$ stream.

For the operation of the analog part, a set of five clock signals is provided from the digital module. These signals derive from the CLK signal. Two of them are used to run the conversion, the next one is used as the chopper signal for the voltage channel and the last two are used as chopper signals for the current channel. All these signals are connected to the control signal module, which consists of standard digital cells powered from an analog supply. It produces all the necessary signals and switch controls of the AD converters.

Figure 18. Block diagram of the modulator



8.3 Functional description of the digital part

A digital part is made up of:

- clock generator
- mode decoder
- time multiplex

The clock generator produces all five clocks for the analog module.

The mode decoder generates signals for controlling the temperature coefficient of the on-chip band-gap voltage reference and the amplification factor of the current channel, clock prescaler, and voltage channel enable.

Table 7. Modes of operation

MS0	Mode	Description
0	0	ampl = 8
1	1	ampl = 32

Table 8. Changing of band-gap voltage reference

MS1	Mode	Description
0	0	TC = 100 ppm/°C
CLK	1	TC = 170 ppm/°C
NCLK	2	TC = 125 ppm/°C
1	3	TC = 190 ppm/°C

The multiplex combines both $\Sigma\Delta$ input signals for the analog module into one signal DAT which drives differential outputs DAT and DATn according to:

DAT= if CLK then bsV or else bsC

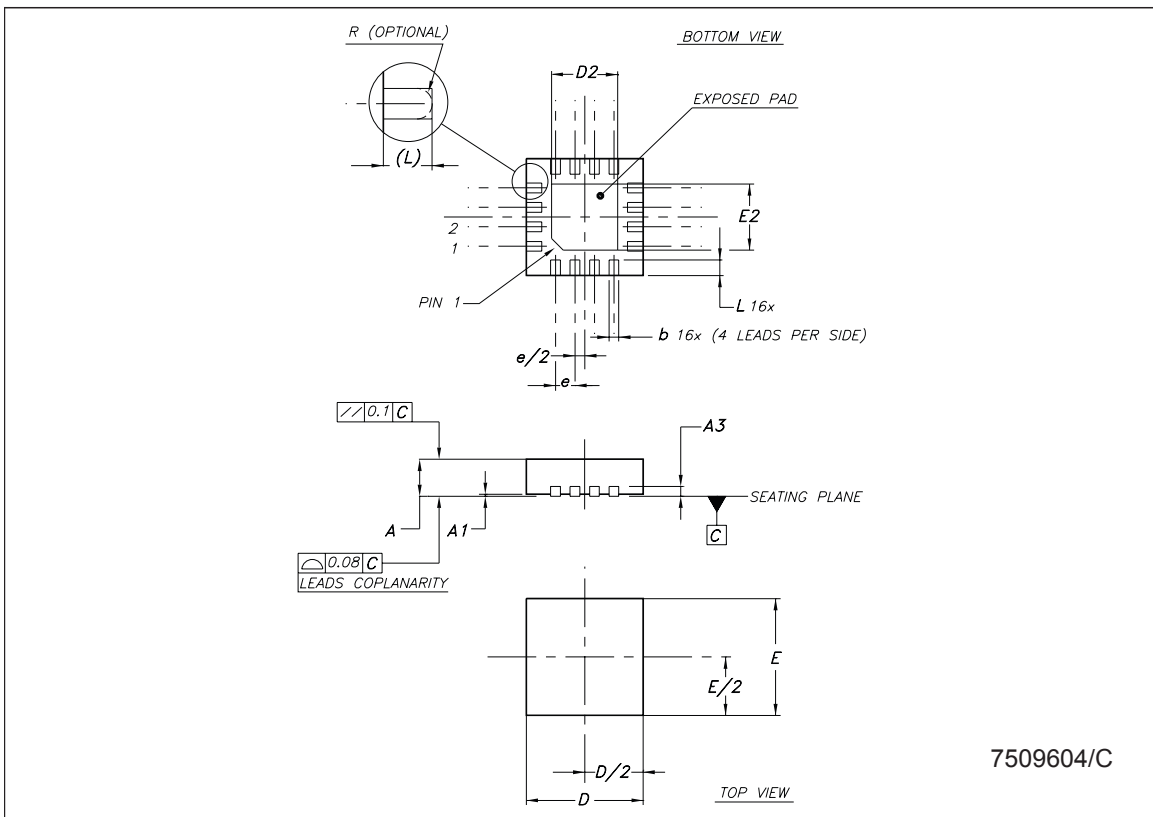
DATN = NOT(DAT).

9 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions, and product status are available at www.st.com. ECOPACK is an ST registered trademark.

QFN16 (3 x 3 mm.) mechanical data

Dim.	mm.			inch.		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	0.80	0.90	1.00	0.031	0.035	0.039
A1	0		0.05			0.002
A3		0.20			0.008	
b	0.18		0.30	0.007		0.012
D	2.90	3.00	3.10	0.114	0.118	0.122
D2	1.50		1.80	0.059		0.071
E		3.00			0.118	
E2	2.90	3.00	3.10	0.114	0.118	0.122
e		0.50			0.020	
L	0.30		0.50	0.012		0.020



Tape & reel QFNxx/DFNxx (3 x 3 mm.) mechanical data

Dim.	mm.			inch.		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A			180			7.087
C	12.8		13.2	0.504		0.519
D	20.2			0.795		
N	60			2.362		
T			14.4			0.567
Ao		3.3			0.130	
Bo		3.3			0.130	
Ko		1.1			0.043	
Po		4			0.157	
P		8			0.315	

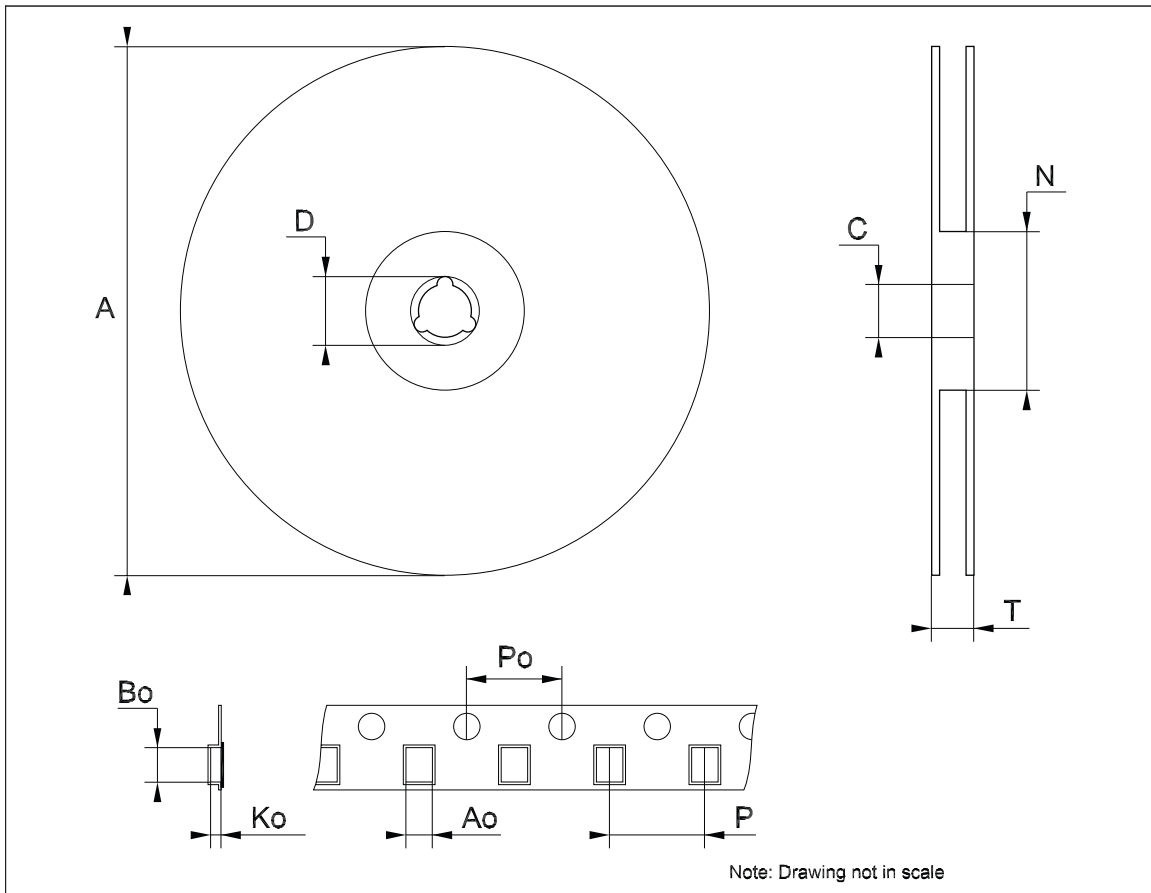
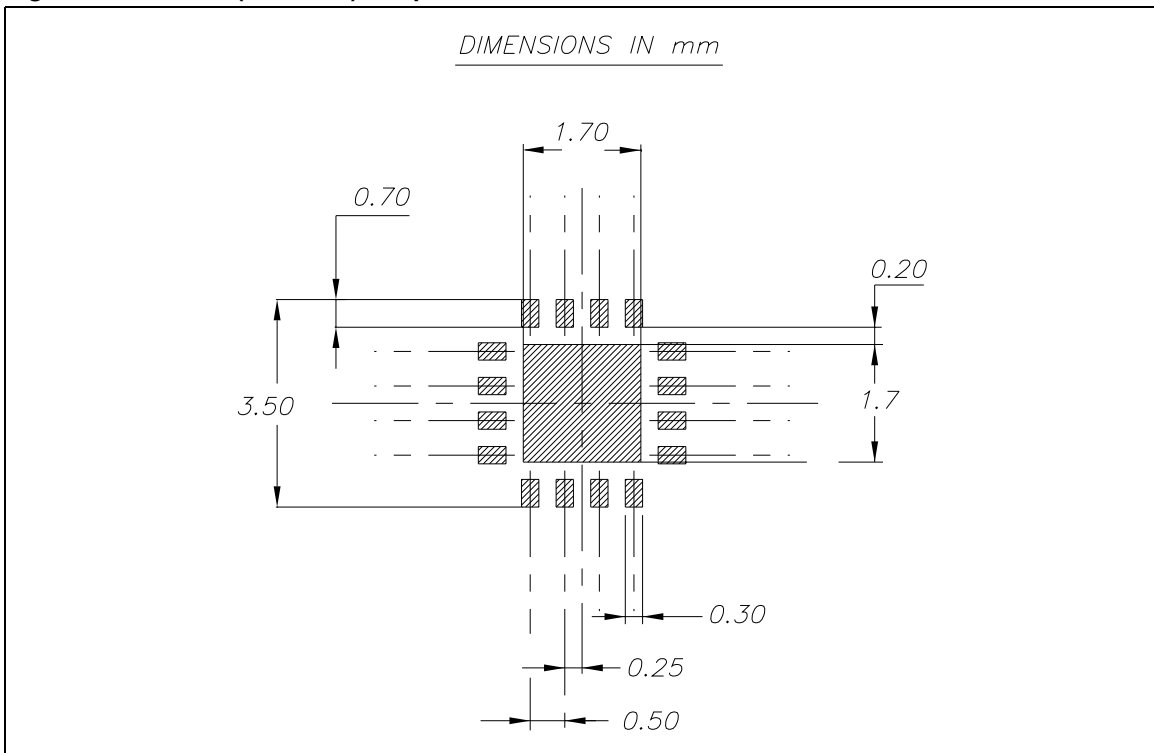


Figure 19. QFN16 (3 x 3 mm) footprint recommended data



10 Revision history

Table 9. Document revision history

Date	Revision	Changes
23-Oct-2009	1	Initial release.
07-Oct-2010	2	Data brief header removed from the cover page.

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